# ESP32-C3 Family

## **Datasheet**

Ultra-Low-Power SoC with RISC-V Single-Core CPU
Supporting IEEE 802.11b/g/n (2.4 GHz Wi-Fi) and Bluetooth 5 (LE)

## Including:

ESP32-C3

ESP32-C3FN4

ESP32-C3FH4



### **Product Overview**

ESP32-C3 family is an ultra-low-power and highly-integrated MCU-based SoC solution that supports 2.4 GHz Wi-Fi and Bluetooth<sup>®</sup> Low Energy (Bluetooth LE). It has:

- A complete Wi-Fi subsystem that complies with IEEE 802.11b/g/n protocol and supports Station mode, SoftAP mode, SoftAP + Station mode, and promiscuous mode
- A Bluetooth LE subsystem that supports features of Bluetooth 5 and Bluetooth mesh
- State-of-the-art power and RF performance
- 32-bit RISC-V single-core processor with a four-stage pipeline that operates at up to 160 MHz
- 400 KB of SRAM (16 KB for cache) and 384 KB of ROM on the chip, and SPI, Dual SPI, Quad

- SPI, and QPI interfaces that allow connection to external flash
- Reliable security features ensured by
  - Cryptographic hardware accelerators that support AES-128/256, Hash, RSA, HMAC, digital signature and secure boot
  - Random number generator
  - Permission control on accessing internal memory, external memory, and peripherals
  - External memory encryption and decryption
- Rich set of peripheral interfaces and GPIOs, ideal for various scenarios and complex applications

## **Block Diagram**

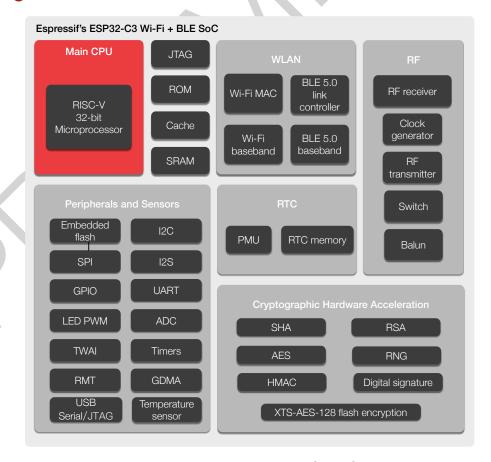


Figure 1: Block Diagram of ESP32-C3

#### **Features**

#### Wi-Fi

- IEEE 802.11 b/g/n-compliant
- Supports 20 MHz, 40 MHz bandwidth in 2.4 GHz band
- 1T1R mode with data rate up to 150 Mbps
- Wi-Fi Multimedia (WMM)
- TX/RX A-MPDU, TX/RX A-MSDU
- Immediate Block ACK
- Fragmentation and defragmentation
- Transmit opportunity (TXOP)
- Automatic Beacon monitoring (hardware TSF)
- 4 × virtual Wi-Fi interfaces
- Simultaneous support for Infrastructure BSS in Station mode, SoftAP mode, Station + SoftAP mode, and promiscuous mode
   Note that when ESP32-C3 family scans in Station mode, the SoftAP channel will change along with the Station channel
- Antenna diversity
- 802.11mc FTM

#### Bluetooth

- Bluetooth LE: Bluetooth 5, Bluetooth mesh
- Speed: 125 Kbps, 500 Kbps, 1 Mbps, 2 Mbps
- Advertising extensions
- Multiple advertisement sets
- Channel selection algorithm #2

#### **CPU and Memory**

- 32-bit RISC-V single-core processor, up to 160 MHz
- 384 KB ROM
- 400 KB SRAM (16 KB for cache)
- 8 KB SRAM in RTC
- Embedded flash (see details in Chapter 1 Family Member Comparison)

 SPI, Dual SPI, Quad SPI, and QPI interfaces that allow connection to multiple external flash

#### **Advanced Peripheral Interfaces**

- 22 × programmable GPIOs
- Digital interfaces:
  - 3 × SPI
  - 2 × UART
  - 1 × I2C
  - $-1 \times 12S$
  - Remote control peripheral, with 2 transmit channels and 2 receive channels
  - LED PWM controller, with up to 6 channels
  - Full-speed USB Serial/JTAG controller
  - General DMA controller (GDMA), with 3 transmit channels and 3 receive channels
  - 1 x TWAI<sup>®</sup> controller (compatible with ISO 11898-1)
- Analog interfaces:
  - 2 × 12-bit SAR ADCs, up to 6 channels
  - 1 × temperature sensor
- Timers:
  - 2 × 54-bit general-purpose timer
  - 3 × watchdog timers

#### Low Power Management

Power Management Unit with five power modes

#### Security

- Secure boot
- Flash encryption
- 4096-bit OTP, up to 1792 bits for users
- Cryptographic hardware acceleration:
  - AES-128/256 (FIPS PUB 197)
- Permission Control

- SHA Accelerator (FIPS PUB 180-4)
- RSA Accelerator
- Random Number Generator (RNG)

- HMAC
- Digital signature

## **Applications (A Non-exhaustive List)**

With ultra-low power consumption, ESP32-C3 family is an ideal choice for IoT devices in the following areas:

- Smart Home
  - Light control
  - Smart button
  - Smart plug
  - Indoor positioning
- Industrial Automation
  - Industrial robot
  - Mesh network
  - Human machine interface (HMI)
  - Industrial field bus
- Health Care
  - Health monitor
  - Baby monitor
- Consumer Electronics
  - Smart watch and bracelet
  - Over-the-top (OTT) devices

- Wi-Fi and Bluetooth speaker
- Logger toys and proximity sensing toys
- Smart Agriculture
  - Smart greenhouse
  - Smart irrigation
  - Agriculture robot
- Retail and Catering
  - POS machines
  - Service robot
- Audio Device
  - Internet music players
  - Live streaming devices
  - Internet radio players
- Generic Low-power IoT Sensor Hubs
- Generic Low-power IoT Data Loggers

## **Contents**

| Bloo<br>Fea            | roduct Overview ck Diagram atures blications             | 1<br>1<br>2<br>3 |
|------------------------|----------------------------------------------------------|------------------|
| <b>1</b><br>1.1<br>1.2 | Family Member Comparison Family Nomenclature Comparison  | 8<br>8<br>8      |
| 2                      | Pin Definition                                           | 9                |
| 2.1                    | Pin Layout                                               | 9                |
| 2.2                    | Pin Description                                          | 9                |
| 2.3                    | Power Scheme                                             | 11               |
| 2.4                    | Strapping Pins                                           | 12               |
| 3                      | Functional Description                                   | 15               |
| 3.1                    | CPU and Memory                                           | 15               |
|                        | 3.1.1 CPU                                                | 15               |
|                        | 3.1.2 Internal Memory                                    | 15               |
|                        | 3.1.3 External Flash                                     | 15               |
|                        | 3.1.4 Address Mapping Structure                          | 16               |
|                        | 3.1.5 Cache                                              | 16               |
| 3.2                    | System Clocks                                            | 16               |
|                        | 3.2.1 CPU Clock                                          | 17               |
|                        | 3.2.2 RTC Clock                                          | 17               |
| 3.3                    |                                                          | 17               |
|                        | 3.3.1 Analog-to-Digital Converter (ADC)                  | 17               |
|                        | 3.3.2 Temperature Sensor                                 | 17               |
| 3.4                    | Digital Peripherals                                      | 17               |
|                        | 3.4.1 General Purpose Input / Output Interface (GPIO)    | 17               |
|                        | 3.4.2 Serial Peripheral Interface (SPI)                  | 19               |
|                        | 3.4.3 Universal Asynchronous Receiver Transmitter (UART) | 20               |
| <                      | 3.4.4 I2C Interface                                      | 20               |
|                        | 3.4.5 I2S Interface                                      | 20               |
|                        | 3.4.6 Remote Control Peripheral                          | 20               |
|                        | 3.4.7 LED PWM Controller                                 | 20               |
|                        | 3.4.8 General DMA Controller                             | 21               |
|                        | 3.4.9 USB Serial/JTAG Controller                         | 21               |
|                        | 3.4.10 TWAI® Controller                                  | 21               |
| 3.5                    |                                                          | 21               |
|                        | 3.5.1 2.4 GHz Receiver                                   | 22               |
|                        | 3.5.2 2.4 GHz Transmitter                                | 22               |
|                        | 3.5.3 Clock Generator                                    | 22               |

| 3.     | 5.4 Wi-Fi Radio and Baseband                        | 22 |
|--------|-----------------------------------------------------|----|
| 3.     | 5.5 Wi-Fi MAC                                       | 23 |
| 3.     | 5.6 Networking Features                             | 23 |
| 3.6 E  | Bluetooth LE                                        | 23 |
| 3.     | 6.1 Bluetooth LE Radio and PHY                      | 23 |
| 3.     | 6.2 Bluetooth LE Link Layer Controller              | 24 |
| 3.7 L  | Low Power Management                                | 24 |
| 3.8    | Γimers                                              | 24 |
| 3.     | 8.1 General Purpose Timers                          | 24 |
| 3.     | 8.2 System Timer                                    | 25 |
| 3.     | 8.3 Watchdog Timers                                 | 25 |
| 3.9 (  | Cryptographic Hardware Accelerators                 | 25 |
| 3.10 F | Physical Security Features                          | 26 |
| 3.11 F | Peripheral Pin Configurations                       | 26 |
| 4 E    | Electrical Characteristics                          | 28 |
| 4.1 A  | Absolute Maximum Ratings                            | 28 |
| 4.2 F  | Recommended Operating Conditions                    | 28 |
| 4.3 \  | VDD_SPI Output Characteristics                      | 28 |
| 4.4    | DC Characteristics (3.3 V, 25 °C)                   | 29 |
| 4.5 A  | ADC Characteristics                                 | 29 |
| 4.6    | Current Consumption                                 | 29 |
| 4.7 F  | Reliability                                         | 30 |
| 4.8 \  | Wi-Fi Radio                                         | 31 |
| 4.     | 8.1 Wi-Fi RF Transmitter (TX) Specifications        | 31 |
| 4.     | 8.2 Wi-Fi RF Receiver (RX) Specifications           | 32 |
| 4.9 E  | Bluetooth LE Radio                                  | 33 |
| 4.     | 9.1 Bluetooth LE RF Transmitter (TX) Specifications | 33 |
| 4.     | 9.2 Bluetooth LE RF Receiver (RX) Specifications    | 35 |
| 5 F    | Package Information                                 | 38 |
| Rev    | vision History                                      | 39 |
| Sol    | utions. Documentation and Legal Information         | 40 |

## **List of Tables**

| 1  | ESP32-C3 Family Member Comparison                                    | 8  |
|----|----------------------------------------------------------------------|----|
| 2  | Pin Description                                                      | 9  |
| 3  | Description of ESP32-C3 Family Power-up and Reset Timing Parameters  | 12 |
| 4  | Strapping Pins                                                       | 13 |
| 5  | Parameter Descriptions of Setup and Hold Times for the Strapping Pin | 14 |
| 6  | IO MUX Pin Functions                                                 | 18 |
| 7  | Power-Up Glitches on Pins                                            | 19 |
| 8  | Connection Between ESP32-C3 Family and External Flash                | 20 |
| 9  | Peripheral Pin Configurations                                        | 26 |
| 10 | Absolute Maximum Ratings                                             | 28 |
| 11 | Recommended Operating Conditions                                     | 28 |
| 12 | VDD_SPI Output Characteristics                                       | 28 |
| 13 | DC Characteristics (3.3 V, 25 °C)                                    | 29 |
| 14 | ADC Characteristics                                                  | 29 |
| 15 | Current Consumption Depending on RF Modes                            | 30 |
| 16 | Current Consumption Depending on Work Modes                          | 30 |
| 17 | Reliability Qualifications                                           | 30 |
| 18 | Wi-Fi Frequency                                                      | 31 |
| 19 | TX Power with Spectral Mask and EVM Meeting 802.11 Standards         | 31 |
| 20 | TX EVM Test                                                          | 31 |
| 21 | RX Sensitivity                                                       | 32 |
| 22 | Maximum RX Level                                                     | 32 |
| 23 | RX Adjacent Channel Rejection                                        | 33 |
| 24 | Bluetooth LE Frequency                                               | 33 |
| 25 | Transmitter Characteristics - Bluetooth LE 1 Mbps                    | 33 |
| 26 | Transmitter Characteristics - Bluetooth LE 2 Mbps                    | 34 |
| 27 | Transmitter Characteristics - Bluetooth LE 125 Kbps                  | 34 |
| 28 | Transmitter Characteristics - Bluetooth LE 500 Kbps                  | 34 |
| 29 | Receiver Characteristics - Bluetooth LE 1 Mbps                       | 35 |
| 30 | Receiver Characteristics - Bluetooth LE 2 Mbps                       | 35 |
| 31 | Receiver Characteristics - Bluetooth LE 125 Kbps                     | 36 |
| 32 | Receiver Characteristics - Bluetooth LE 500 Kbps                     | 36 |

## **List of Figures**

| 1 | Block Diagram of ESP32-C3                  |          | 1  |
|---|--------------------------------------------|----------|----|
| 2 | ESP32-C3 Family Nomenclature               |          | 8  |
| 3 | ESP32-C3 Pin Layout (Top View)             |          | Ç  |
| 4 | ESP32-C3 Family Power Scheme               |          | 11 |
| 5 | ESP32-C3 Family Power-up and Reset Timing  |          | 12 |
| 6 | Setup and Hold Times for the Strapping Pin | <b>A</b> | 13 |
| 7 | Address Mapping Structure                  |          | 16 |
| 8 | QFN32 (5×5 mm) Package                     |          | 38 |
|   |                                            |          |    |

## **Family Member Comparison**

#### **Family Nomenclature** 1.1

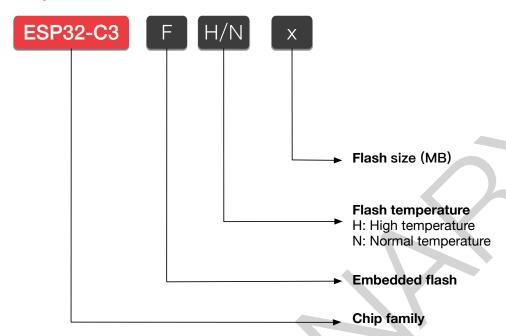


Figure 2: ESP32-C3 Family Nomenclature

#### Comparison 1.2

Table 1: ESP32-C3 Family Member Comparison

| Ordering Code | Embedded Flash | Ambient Temperature (°C) | Package (mm) |
|---------------|----------------|--------------------------|--------------|
| ESP32-C3      |                | <b>−</b> 40 ~ 105        | QFN32 (5*5)  |
| ESP32-C3FN4   | 4 MB           | <b>−</b> 40 ~ 85         | QFN32 (5*5)  |
| ESP32-C3FH4   | 4 MB           | <b>−</b> 40 ~ 105        | QFN32 (5*5)  |

#### **Pin Definition** 2.

#### 2.1 Pin Layout

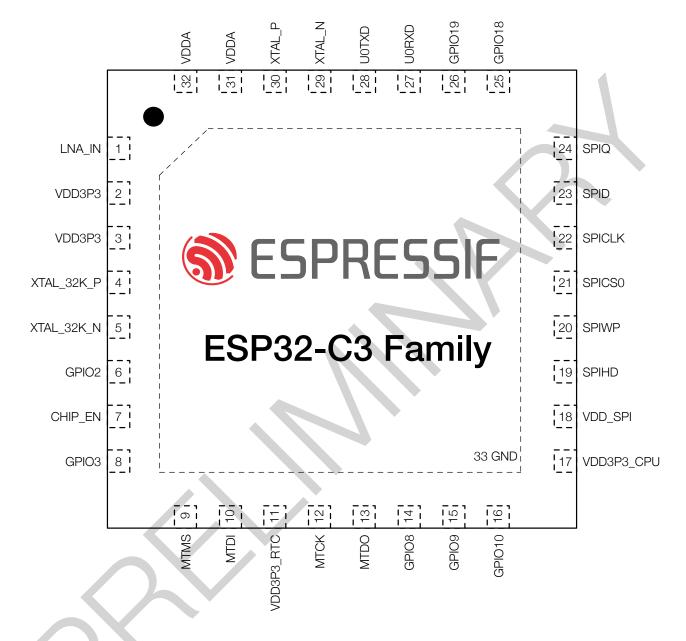


Figure 3: ESP32-C3 Pin Layout (Top View)

#### **Pin Description** 2.2

Table 2: Pin Description

| Name       | No. | Type  | Power Domain | Function                    |  |
|------------|-----|-------|--------------|-----------------------------|--|
| LNA_IN     | 1   | I/O   | _            | RF input and output         |  |
| VDD3P3     | 2   | $P_A$ | _            | Analog power supply         |  |
| VDD3P3     | 3   | $P_A$ | _            | Analog power supply         |  |
| XTAL_32K_P | 4   | I/O/T | VDD3P3_RTC   | GPIO0, ADC1_CH0, XTAL_32K_P |  |

| Name       | No. | Type                 | Power Domain | Function                                     |
|------------|-----|----------------------|--------------|----------------------------------------------|
| XTAL_32K_N | 5   | I/O/T                | VDD3P3_RTC   | GPIO1, ADC1_CH1, XTAL_32K_N                  |
| GPIO2      | 6   | I/O/T                | VDD3P3_RTC   | GPIO2, ADC1_CH2, FSPIQ                       |
|            |     |                      |              | High: on, enables the chip.                  |
| CHIP_EN    | 7   | l                    | VDD3P3_RTC   | Low: off, the chip powers off.               |
|            |     |                      |              | Note: Do not leave the CHIP_EN pin floating. |
| GPIO3      | 8   | I/O/T                | VDD3P3_RTC   | GPIO3, ADC1_CH3                              |
| MTMS       | 9   | I/O/T                | VDD3P3_RTC   | GPIO4, ADC1_CH4, FSPIHD, MTMS                |
| MTDI       | 10  | I/O/T                | VDD3P3_RTC   | GPIO5, ADC2_CH0, FSPIWP, MTDI                |
| VDD3P3_RTC | 11  | $P_D$                | _            | Input power supply for RTC                   |
| MTCK       | 12  | I/O/T                | VDD3P3_CPU   | GPIO6, FSPICLK, MTCK                         |
| MTDO       | 13  | I/O/T                | VDD3P3_CPU   | GPIO7, FSPID, MTDO                           |
| GPIO8      | 14  | I/O/T                | VDD3P3_CPU   | GPIO8                                        |
| GPIO9      | 15  | I/O/T                | VDD3P3_CPU   | GPIO9                                        |
| GPIO10     | 16  | I/O/T                | VDD3P3_CPU   | GPIO10, FSPICS0                              |
| VDD3P3_CPU | 17  | $P_D$                | _            | Input power supply for CPU IO                |
| VDD_SPI    | 18  | I/O/T/P <sub>D</sub> | VDD3P3_CPU   | GPIO11, output power supply for flash        |
| SPIHD      | 19  | I/O/T                | VDD3P3_CPU   | GPIO12, SPIHD                                |
| SPIWP      | 20  | I/O/T                | VDD3P3_CPU   | GPIO13, SPIWP                                |
| SPICS0     | 21  | I/O/T                | VDD3P3_CPU   | GPIO14, SPICS0                               |
| SPICLK     | 22  | I/O/T                | VDD3P3_CPU   | GPIO15, SPICLK                               |
| SPID       | 23  | I/O/T                | VDD3P3_CPU   | GPIO16, SPID                                 |
| SPIQ       | 24  | I/O/T                | VDD3P3_CPU   | GPIO17, SPIQ                                 |
| GPIO18     | 25  | I/O/T                | VDD3P3_CPU   | GPIO18, USB_D-                               |
| GPIO19     | 26  | I/O/T                | VDD3P3_CPU   | GPIO19, USB_D+                               |
| U0RXD      | 27  | I/O/T                | VDD3P3_CPU   | GPIO20, U0RXD                                |
| U0TXD      | 28  | I/O/T                | VDD3P3_CPU   | GPIO21, U0TXD                                |
| XTAL_N     | 29  | /-                   | ->           | External crystal output                      |
| XTAL_P     | 30  |                      |              | External crystal input                       |
| VDDA       | 31  | $P_A$                |              | Analog power supply                          |
| VDDA       | 32  | $P_A$                | _            | Analog power supply                          |
| GND        | 33  | G                    | _            | Ground                                       |

<sup>&</sup>lt;sup>1</sup>  $P_A$ : analog power supply;  $P_D$ : power supply for RTC IO; I: input; O: output; T: high impedance.

- CS# = SPICS0
- 100/DI = SPID
- IO1/DO = SPIQ
- CLK = SPICLK
- IO2/WP# = SPIWP
- IO3/HOLD# = SPIHD

These pins are not recommended for other uses.

<sup>&</sup>lt;sup>2</sup> Ports of embedded flash correspond to pins of ESP32-C3FN4 and ESP32-C3FH4 as follows:

<sup>&</sup>lt;sup>3</sup> For the data port connection between ESP32-C3 family and external flash please refer to Section 3.4.2 Serial Peripheral Interface (SPI).

<sup>&</sup>lt;sup>4</sup> The pin function in this table refers only to some fixed settings and do not cover all cases for signals that can be input and output through the GPIO matrix. For more information on the GPIO matrix, please refer to Chapter IO MUX and GPIO Matrix (GPIO, IO\_MUX) in <u>ESP32-C3 Technical Reference Manual</u>.

#### 2.3 **Power Scheme**

Digital pins of ESP32-C3 family are divided into four different power domains:

- VDD3P3\_CPU
- VDD\_SPI
- VDD3P3\_RTC

VDD3P3\_CPU is the input power supply for CPU.

VDD\_SPI can be an input power supply or an output power supply.

VDD3P3\_RTC is the input power supply for RTC analog domain and CPU.

The power scheme diagram is shown in Figure 4.

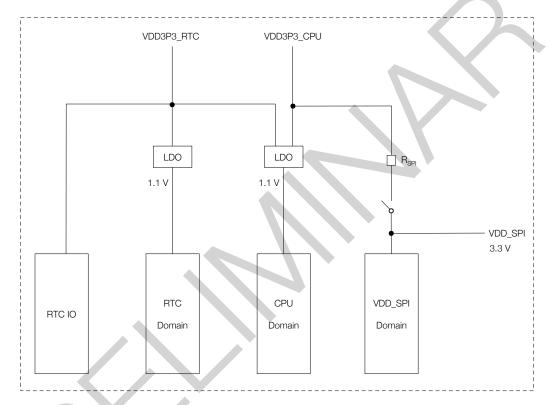


Figure 4: ESP32-C3 Family Power Scheme

When working as an output power supply, VDD\_SPI can be powered by VDD3P3\_CPU via  $R_{SPI}$  (nominal 3.3 V). VDD\_SPI can be powered off via software to minimize the current leakage of flash in Deep-sleep mode.

#### Notes on CHIP\_EN:

Figure 5 shows the power-up and reset timing of ESP32-C3 family. Details about the parameters are listed in Table 3.

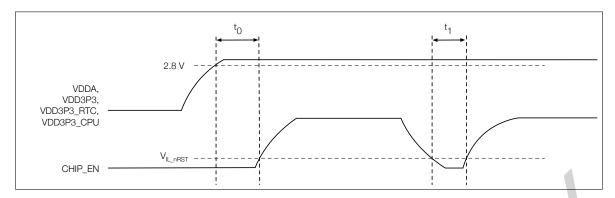


Figure 5: ESP32-C3 Family Power-up and Reset Timing

Table 3: Description of ESP32-C3 Family Power-up and Reset Timing Parameters

| Parameter      | r Description                                                                                           |    |
|----------------|---------------------------------------------------------------------------------------------------------|----|
| t <sub>0</sub> | Time between bringing up the VDDA, VDD3P3, VDD3P3_RTC, and VDD3P3_CPU rails, and activating CHIP_EN     | 50 |
| t <sub>1</sub> | Duration of CHIP_EN signal level $<$ V $_{IL\_nRST}$ (refer to its value in Table 13) to reset the chip | 50 |

## 2.4 Strapping Pins

ESP32-C3 family has four strapping pins:

- GPI02
- GPI08
- GPI09
- GPIO10

Software can read the values of GPIO2, GPIO8 and GPIO10 from GPIO\_STRAPPING field in GPIO\_STRAP\_REG register. For register description, please refer to Section GPIO Matrix Register Summary in ESP32-C3 Technical Reference Manual.

During the chip's system reset, the latches of the strapping pins sample the voltage level as strapping bits of "0" or "1", and hold these bits until the chip is powered down or shut down.

Types of system reset include:

- power-on-reset
- RTC watchdog reset
- brownout reset
- analog super watchdog reset
- crystal clock glitch detection reset

By default, GPIO9 is connected to the internal pull-up resistor. If GPIO9 is not connected or connected to an external high-impedance circuit, the latched bit value will be "1"

To change the strapping bit values, you can apply the external pull-down/pull-up resistances, or use the host MCU's GPIOs to control the voltage level of these pins when powering on ESP32-C3 family.

After reset, the strapping pins work as normal-function pins.

Refer to Table 4 for a detailed boot-mode configuration of the strapping pins.

Table 4: Strapping Pins

| Booting Mode <sup>1</sup> |                  |                                                                    |                                    |  |  |
|---------------------------|------------------|--------------------------------------------------------------------|------------------------------------|--|--|
| Pin                       | Default          | SPI Boot                                                           | Download Boot                      |  |  |
| GPIO2                     | N/A              | 1                                                                  | 1                                  |  |  |
| GPIO8                     | N/A              | Don't care                                                         | 1                                  |  |  |
| GPIO9                     | Internal pull-up | 1                                                                  | 0                                  |  |  |
|                           | Enak             | oling/Disabling ROM Code Print Du                                  | ring Booting                       |  |  |
| Pin                       | Default          | Functionality                                                      |                                    |  |  |
|                           |                  | When the value of eFuse field EFUS                                 | E_UART_PRINT_CONTROL is            |  |  |
|                           | N/A              | 0 (default), print is enabled and not controlled by GPIO8.         |                                    |  |  |
| GPIO8                     |                  | 1, if GPIO8 is 0, print is enabled; if GPIO8 is 1, it is disabled. |                                    |  |  |
|                           |                  | 2, if GPIO8 is 0, print is disabled; if 0                          | GPIO8 is 1, it is enabled.         |  |  |
|                           |                  | 3, print is disabled and not controlled by GPIO8.                  |                                    |  |  |
|                           | Co               | ontrolling JTAG Signal Source Durin                                | g Booting                          |  |  |
| Pin                       | Default          | Functionality                                                      |                                    |  |  |
|                           |                  | When the value of eFuse bit EFUSE                                  | _STRAP_JTAG_SEL is                 |  |  |
| GPIO10                    | N/A              | 0 (default), JTAG signals come from USB Serial/JTAG controller.    |                                    |  |  |
| di lo io                  | IN/A             | 1, if GPIO10 is 0, JTAG signals come from chip pins;               |                                    |  |  |
|                           |                  | if GPIO10 is 1, JTAG signals com                                   | e from USB Serial/JTAG controller. |  |  |

<sup>&</sup>lt;sup>1</sup> The strapping combination of GPIO8 = 0 and GPIO9 = 0 is invalid and will trigger unexpected behavior.

Figure 6 shows the setup and hold times for the strapping pin before and after the CHIP\_EN signal goes high. Details about the parameters are listed in Table 5.

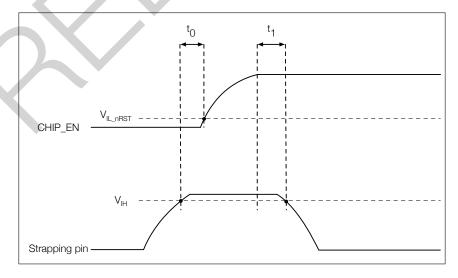


Figure 6: Setup and Hold Times for the Strapping Pin

Table 5: Parameter Descriptions of Setup and Hold Times for the Strapping Pin

| Parameter      | Description                                     |   |
|----------------|-------------------------------------------------|---|
| $t_0$          | Setup time before CHIP_EN goes from low to high | 0 |
| t <sub>1</sub> | Hold time after CHIP_EN goes high               | 3 |



## 3. Functional Description

This chapter describes the functions of ESP32-C3 family.

### 3.1 CPU and Memory

#### 3.1.1 CPU

ESP32-C3 family has a low-power 32-bit RISC-V single-core microprocessor with the following features:

- four-stage pipeline that supports a clock frequency of up to 160 MHz
- RV32IMC ISA
- 32-bit multiplier and 32-bit divider
- up to 32 vectored interrupts at seven priority levels
- up to 8 hardware breakpoints/watchpoints
- up to 16 PMP regions
- JTAG for debugging

#### 3.1.2 Internal Memory

ESP32-C3's internal memory includes:

- 384 KB of ROM: for booting and core functions.
- 400 KB of on-chip SRAM: for data and instructions. Of the 400 KB SRAM, 16 KB is configured for cache
- RTC memory: 8 KB of SRAM that can be accessed by the main CPU. It can retain data in Deep-sleep mode.
- 4 Kbit of eFuse: 1792 bits are reserved for user data, such as encryption key and device ID.
- Embedded flash: See details in Chapter 1 Family Member Comparison.

#### 3.1.3 External Flash

ESP32-C3 family supports SPI, Dual SPI, Quad SPI, and QPI interfaces that allow connection to multiple external flash.

CPU's instruction memory space and read-only data memory space can map into external flash of ESP32-C3, whose size can be 16 MB at most. ESP32-C3 family supports hardware encryption/decryption based on XTS-AES to protect developers' programs and data in flash.

Through high-speed caches, ESP32-C3 family can support at a time up to:

- 8 MB of instruction memory space which can map into flash as individual blocks of 64 KB. 8-bit, 16-bit and 32-bit reads are supported.
- 8 MB of data memory space which can map into flash as individual blocks of 64 KB. 8-bit, 16-bit and 32-bit reads are supported.

#### Note:

After ESP32-C3 family is initialized, software can customize the mapping of external flash into the CPU address space.

#### 3.1.4 Address Mapping Structure

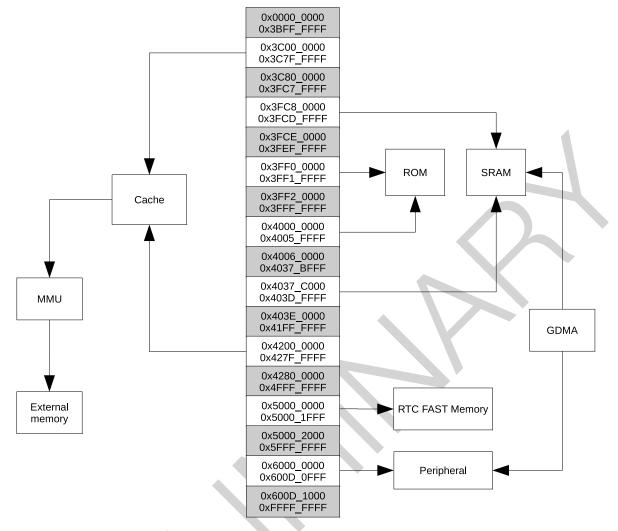


Figure 7: Address Mapping Structure

#### Note:

The memory space with gray background is not available for use.

#### 3.1.5 Cache

ESP32-C3 family has an eight-way set associative cache. This cache is read-only and has the following features:

- size: 16 KB
- block size: 32 bytes
- pre-load function
- lock function
- critical word first and early restart

## 3.2 System Clocks

#### 3.2.1 CPU Clock

The CPU clock has three possible sources:

- external main crystal clock
- internal 20 MHz oscillator
- PLL clock

The application can select the clock source from the three clocks above. The selected clock source drives the CPU clock directly, or after division, depending on the application.

#### 3.2.2 RTC Clock

The RTC slow clock is used for RTC counter, RTC watchdog and low-power controller. It has three possible sources:

- external low-speed (32 kHz) crystal clock
- internal RC oscillator (typically about 150 kHz, and adjustable)
- internal 78.125 kHz clock (derived from the internal 20 MHz oscillator divided by 256)

The RTC fast clock is used for RTC peripherals and sensor controllers. It has two possible sources:

- external main crystal clock divided by 2
- internal 20 MHz oscillator

### 3.3 Analog Peripherals

#### 3.3.1 Analog-to-Digital Converter (ADC)

ESP32-C3 family integrates two 12-bit SAR ADCs and supports measurements on 6 channels (analog-enabled pins). For ADC characteristics, please refer to Table 14.

#### 3.3.2 Temperature Sensor

The temperature sensor generates a voltage that varies with temperature. The voltage is internally converted via an ADC into a digital value.

The temperature sensor has a range of -40 °C to 125 °C. It is designed primarily to sense the temperature changes inside the chip. The temperature value depends on factors like microcontroller clock frequency or I/O load. Generally, the chip's internal temperature is higher than the ambient temperature.

## 3.4 Digital Peripherals

#### 3.4.1 General Purpose Input / Output Interface (GPIO)

ESP32-C3 family has 22 GPIO pins which can be assigned various functions by configuring corresponding registers. Besides digital signals, some GPIOs can be also used for analog functions, such as ADC.

All GPIOs have selectable internal pull-up or pull-down, or can be set to high impedance. When these GPIOs are configured as an input, the input value can be read by software through the register. Input GPIOs can also be set to generate edge-triggered or level-triggered CPU interrupts. All digital IO pins are bi-directional, non-inverting and tristate, including input and output buffers with tristate control. These pins can be multiplexed with other functions, such as the UART, SPI, etc. For low-power operations, the GPIOs can be set to holding state.

The IO MUX and the GPIO matrix are used to route signals from peripherals to GPIO pins. Together they provide highly configurable I/O. Using GPIO Matrix, peripheral input signals can be configured from any IO pins while peripheral output signals can be configured to any IO pins. Table 6 shows the IO MUX functions of each pin. For more information about IO MUX and GPIO matrix, please refer to Chapter IO MUX and GPIO Matrix (GPIO, IO\_MUX) in ESP32-C3 Technical Reference Manual.

Table 6: IO MUX Pin Functions

| Name       | No. | Function 0 | Function 1 | Function 2          | Reset | Notes  |
|------------|-----|------------|------------|---------------------|-------|--------|
| XTAL_32K_P | 4   | GPIO0      | GPIO0      | _                   | 0     | R      |
| XTAL_32K_N | 5   | GPIO1      | GPIO1      | _                   | 0     | R      |
| GPIO2      | 6   | GPIO2      | GPIO2      | FSPIQ               | 1     | R      |
| GPIO3      | 8   | GPIO3      | GPIO3      | _                   | 1     | R      |
| MTMS       | 9   | MTMS       | GPIO4      | FSPIHD              | 1     | R      |
| MTDI       | 10  | MTDI       | GPIO5      | FSPIWP              | 1     | R      |
| MTCK       | 12  | MTCK       | GPIO6      | FSPICLK             | 1*    | G      |
| MTDO       | 13  | MTDO       | GPIO7      | FSPID               | 1     | G      |
| GPIO8      | 14  | GPIO8      | GPIO8      | <b>\</b> - <b>\</b> | 1     | _      |
| GPIO9      | 15  | GPIO9      | GPIO9      | _                   | 3     | _      |
| GPIO10     | 16  | GPIO10     | GPIO10     | FSPICS0             | 1     | G      |
| VDD_SPI    | 18  | GPIO11     | GPIO11     |                     | 0     | _      |
| SPIHD      | 19  | SPIHD      | GPIO12     | _                   | 3     | _      |
| SPIWP      | 20  | SPIWP      | GPIO13     | _                   | 3     | _      |
| SPICS0     | 21  | SPICS0     | GPIO14     | _                   | 3     | _      |
| SPICLK     | 22  | SPICLK     | GPIO15     | _                   | 3     | _      |
| SPID       | 23  | SPID       | GPIO16     | _                   | 3     | _      |
| SPIQ       | 24  | SPIQ       | GPIO17     | _                   | 3     | _      |
| GPIO18     | 25  | GPIO18     | GPIO18     | _                   | 0     | USB, G |
| GPIO19     | 26  | GPIO19     | GPIO19     | _                   | 0*    | USB    |
| UORXD      | 27  | U0RXD      | GPIO20     | _                   | 1     | G      |
| U0TXD      | 28  | UOTXD      | GPIO21     | _                   | 1     | _      |

#### Reset

The default configuration of each pin after reset:

- 0 input disabled, in high impedance state (IE = 0)
- 1 input enabled, in high impedance state (IE = 1)
- 2 input enabled, pull-down resistor enabled (IE = 1, WPD = 1)
- 3 input enabled, pull-up resistor enabled (IE = 1, WPU = 1)
- 0\* input disabled, pull-up resistor enabled (IE = 0, WPU = 0, USB\_WPU = 1). See details in Notes
- 1\* When the value of eFuse bit EFUSE DIS PAD JTAG is
  - 0, input enabled, pull-up resistor enabled (IE = 1, WPU = 1)
  - 1, input enabled, in high impedance state (IE = 1)

We recommend pulling high or low GPIO pins in high impedance state to avoid unnecessary power

consumption. You may add pull-up and pull-down resistors in your PCB design referring to Table 13, or enable internal pull-up and pull-down resistors during software initialization.

#### **Notes**

- R These pins have analog functions.
- USB GPIO18 and GPIO19 are USB pins. The pull-up value of a USB pin is controlled by the pin's pull-up value together with USB pull-up value. If any of the two pull-up values is 1, the pin's pull-up resistor will be enabled. The pull-up resistors of USB pins are controlled by USB\_SERIAL\_JTAG\_DP\_PULLUP bit.
- G These pins have glitches during power-up. See details in Table 7.

| Pin    | Glitch           | Typical Time Period (ns) |
|--------|------------------|--------------------------|
| MTCK   | Low-level glitch | 5                        |
| MTDO   | Low-level glitch | 5                        |
| GPIO10 | Low-level glitch | 5                        |
| UORXD  | Low-level glitch | 5                        |
| GPIO18 | Pull-up glitch   | 50000                    |

Table 7: Power-Up Glitches on Pins

#### 3.4.2 Serial Peripheral Interface (SPI)

ESP32-C3 family features three SPI interfaces (SPI0, SPI1, and SPI2). SPI0 and SPI1 can only be configured to operate in SPI memory mode, while SPI2 can be configured to operate in both SPI memory and general-purpose SPI modes.

#### SPI Memory mode

In SPI memory mode, SPI0, SPI1 and SPI2 interface with external SPI memory. Data is transferred in bytes. Up to four-line STR reads and writes are supported. The clock frequency is configurable to a maximum of 120 MHz in STR mode.

#### • SPI2 General-purpose SPI (GP-SPI) mode

When SPI2 acts as a general-purpose SPI, it can operate in master and slave modes. SPI2 supports two-line full-duplex communication and single-/two-/four-line half-duplex communication in both master and slave modes. The host's clock frequency is configurable. Data is transferred in bytes. The clock polarity (CPOL) and phase (CPHA) are also configurable. The SPI2 interface can connect to GDMA.

- In master mode, the clock frequency is 80 MHz at most, and the four modes of SPI transfer format are supported.
- In slave mode, the clock frequency is 60 MHz at most, and the four modes of SPI transfer format are also supported.

In most cases, the data port connection between ESP32-C3 family and external flash is as follows:

Table 8: Connection Between ESP32-C3 Family and External Flash

| Chip Pin      | External Flash Data Port |                   |                    |  |  |  |
|---------------|--------------------------|-------------------|--------------------|--|--|--|
| Chip Fili     | SPI Single-Line Mode     | SPI Two-Line Mode | SPI Four-Line Mode |  |  |  |
| SPID (SPID)   | DI                       | 100               | 100                |  |  |  |
| SPIQ (SPIQ)   | DO                       | IO1               | IO1                |  |  |  |
| SPIWP (SPIWP) | WP#                      | _                 | 102                |  |  |  |
| SPIHD (SPIHD) | HOLD#                    | _                 | IO3                |  |  |  |

#### 3.4.3 Universal Asynchronous Receiver Transmitter (UART)

ESP32-C3 family has two UART interfaces, i.e. UART0 and UART1, which support IrDA and asynchronous communication (RS232 and RS485) at a speed of up to 5 Mbps. The UART controller provides hardware flow control (CTS and RTS signals) and software flow control (XON and XOFF). Both UART interfaces connect to GDMA via UHCl0, and can be accessed by the GDMA controller or directly by the CPU.

#### 3.4.4 I2C Interface

ESP32-C3 family has an I2C bus interface which is used for I2C master mode or slave mode, depending on the user's configuration. The I2C interface supports:

- standard mode (100 Kbit/s)
- fast mode (400 Kbit/s)
- up to 800 Kbit/s (constrained by SCL and SDA pull-up strength)
- 7-bit and 10-bit addressing mode
- double addressing mode
- 7-bit broadcast address

Users can configure instruction registers to control the I2C interface for more flexibility.

#### 3.4.5 I2S Interface

ESP32-C3 family includes a standard I2S interface. This interface can operate as a master or a slave in full-duplex mode or half-duplex mode, and can be configured for 8-bit, 16-bit, 24-bit, or 32-bit serial communication. BCK clock frequency, from 10 kHz up to 40 MHz, is supported.

The I2S interface supports TDM PCM, TDM MSB alignment, TDM standard, and PDM TX interface. It connects to the GDMA controller.

#### 3.4.6 Remote Control Peripheral

The Remote Control Peripheral (RMT) supports two channels of infrared remote transmission and two channels of infrared remote reception. By controlling pulse waveform through software, it supports various infrared and other single wire protocols. All four channels share a  $192 \times 32$ -bit memory block to store transmit or receive waveform.

#### 3.4.7 LED PWM Controller

The LED PWM controller can generate independent digital waveform on six channels. The LED PWM controller:

• can generate digital waveform with configurable periods and duty cycle. The accuracy of duty cycle can be

up to 18 bits.

- has multiple clock sources, including APB clock and external main crystal clock.
- can operate when the CPU is in Light-sleep mode.
- supports gradual increase or decrease of duty cycle, which is useful for the LED RGB color-gradient generator.

#### 3.4.8 General DMA Controller

ESP32-C3 family has a general DMA controller (GDMA) with six independent channels, i.e. three transmit channels and three receive channels. These six channels are shared by peripherals with DMA feature. The GDMA controller implements a fixed-priority scheme among these channels.

The GDMA controller controls data transfer using linked lists. It allows peripheral-to-memory and memory-to-memory data transfer at a high speed. All channels can access internal RAM.

Peripherals on ESP32-C3 family with DMA feature are SPI2, UHCI0, I2S, AES, SHA, and ADC.

#### 3.4.9 USB Serial/JTAG Controller

ESP32-C3 integrates a USB Serial/JTAG controller. This controller has the following features:

- USB 2.0 full speed compliant, capable of up to 12 Mbit/s transfer speed (Note that this controller does not support the faster 480 Mbit/s high-speed transfer mode)
- CDC-ACM virtual serial port and JTAG adapter functionality
- programming embedded/external flash
- CPU debugging with compact JTAG instructions
- a full-speed USB PHY integrated in the chip

#### 3.4.10 TWAI® Controller

ESP32-C3 family has a TWAI® controller with the following features:

- compatible with ISO 11898-1 protocol
- standard frame format (11-bit ID) and extended frame format (29-bit ID)
- bit rates from 1 Kbit/s to 1 Mbit/s
- multiple modes of operation: Normal, Listen Only, and Self-Test (no acknowledgment required)
- 64-byte receive FIFO
- acceptance filter (single and dual filter modes)
- error detection and handling: error counters, configurable error interrupt threshold, error code capture, arbitration lost capture

#### 3.5 Radio and Wi-Fi

The ESP32-C3 family radio consists of the following blocks:

- 2.4 GHz receiver
- 2.4 GHz transmitter
- bias and regulators

- balun and transmit-receive switch
- clock generator

#### 3.5.1 2.4 GHz Receiver

The 2.4 GHz receiver demodulates the 2.4 GHz RF signal to guadrature baseband signals and converts them to the digital domain with two high-resolution, high-speed ADCs. To adapt to varying signal channel conditions, ESP32-C3 family integrates RF filters, Automatic Gain Control (AGC), DC offset cancelation circuits, and baseband filters.

#### 3.5.2 2.4 GHz Transmitter

The 2.4 GHz transmitter modulates the quadrature baseband signals to the 2.4 GHz RF signal, and drives the antenna with a high-powered CMOS power amplifier. The use of digital calibration further improves the linearity of the power amplifier.

Additional calibrations are integrated to cancel any radio imperfections, such as:

- · carrier leakage
- I/Q amplitude/phase matching
- baseband nonlinearities
- RF nonlinearities
- · antenna matching

These built-in calibration routines reduce the cost, time, and specialized equipment required for product testing.

#### 3.5.3 Clock Generator

The clock generator produces quadrature clock signals of 2.4 GHz for both the receiver and the transmitter. All components of the clock generator are integrated into the chip, including inductors, varactors, filters, regulators and dividers.

The clock generator has built-in calibration and self-test circuits. Quadrature clock phases and phase noise are optimized on chip with patented calibration algorithms which ensure the best performance of the receiver and the transmitter.

#### Wi-Fi Radio and Baseband

The ESP32-C3 family Wi-Fi radio and baseband support the following features:

- 802.11b/g/n
- 802.11n MCS0-7 that supports 20 MHz and 40 MHz bandwidth
- 802.11n MCS32
- 802.11n 0.4 μs guard interval
- data rate up to 150 Mbps
- RX STBC (single spatial stream)
- adjustable transmitting power
- antenna diversity ESP32-C3 family supports antenna diversity with an external RF switch. This switch is controlled by one or

more GPIOs, and used to select the best antenna to minimize the effects of channel imperfections.

#### 3.5.5 Wi-Fi MAC

ESP32-C3 family implements the full 802.11 b/g/n Wi-Fi MAC protocol. It supports the Basic Service Set (BSS) STA and SoftAP operations under the Distributed Control Function (DCF). Power management is handled automatically with minimal host interaction to minimize the active duty period.

The ESP32-C3 family Wi-Fi MAC applies the following low-level protocol functions automatically:

- 4 × virtual Wi-Fi interfaces
- infrastructure BSS in Station mode, SoftAP mode, Station + SoftAP mode, and promiscuous mode
- RTS protection, CTS protection, Immediate Block ACK
- fragmentation and defragmentation
- TX/RX A-MPDU, TX/RX A-MSDU
- transmit opportunity (TXOP)
- Wi-Fi multimedia (WMM)
- GCMP, CCMP, TKIP, WAPI, WEP, BIP, WPA2-PSK/WPA2-Enterprise, and WPA3-PSK/WPA3-Enterprise
- automatic beacon monitoring (hardware TSF)
- 802.11mc FTM

#### 3.5.6 Networking Features

Espressif provides libraries for TCP/IP networking, ESP-WIFI-MESH networking, and other networking protocols over Wi-Fi. TLS 1.0, 1.1 and 1.2 is also supported.

#### 3.6 Bluetooth LE

ESP32-C3 family includes a Bluetooth Low Energy subsystem that integrates a hardware link layer controller, an RF/modem block and a feature-rich software protocol stack. It supports the core features of Bluetooth 5 and Bluetooth mesh.

#### 3.6.1 Bluetooth LE Radio and PHY

Bluetooth Low Energy radio and PHY in ESP32-C3 family support:

- 1 Mbps PHY
- 2 Mbps PHY for higher data rates
- coded PHY for longer range (125 Kbps and 500 Kbps)
- listen before talk (LBT), implemented in hardware
- antenna diversity with an external RF switch
   This switch is controlled by one or more GPIOs, and used to select the best antenna to minimize the effects of channel imperfections.

#### 3.6.2 Bluetooth LE Link Layer Controller

Bluetooth Low Energy Link Layer Controller in ESP32-C3 family support:

- · LE advertising extensions, to enhance broadcasting capacity and broadcast more intelligent data
- multiple advertisement sets
- · simultaneous advertising and scanning
- multiple connections in simultaneous central and peripheral roles
- adaptive frequency hopping and channel assessment
- LE channel selection algorithm #2
- connection parameter update
- high duty cycle non-connectable advertising
- LE privacy 1.2
- LE data packet length extension
- link layer extended scanner filter policies
- low duty cycle directed advertising
- link layer encryption
- LE Ping

### 3.7 Low Power Management

With the use of advanced power-management technologies, ESP32-C3 family can switch between different power modes.

- Active mode: CPU and chip radio are powered on. The chip can receive, transmit, or listen.
- Modem-sleep mode: The CPU is operational and the clock speed can be reduced. Wi-Fi base band,
   Bluetooth LE base band, and radio are disabled, but Wi-Fi and Bluetooth LE connection can remain active.
- Light-sleep mode: The CPU is paused. Any wake-up events (MAC, host, RTC timer, or external interrupts) will wake up the chip. Wi-Fi and Bluetooth LE connection can remain active.
- Deep-sleep mode: CPU and most peripherals are powered down. Only the RTC memory is powered on. Wi-Fi connection data are stored in the RTC memory.
- Hibernation mode: The internal 20-MHz oscillator is disabled. Only one RTC timer on the slow clock is active. The RTC timer or the RTC GPIOs can wake up the chip from the Hibernation mode.

For power consumption in different power modes, please refer to Table 16.

#### 3.8 Timers

#### 3.8.1 General Purpose Timers

ESP32-C3 family is embedded with two 54-bit general-purpose timers, which are based on 16-bit prescalers and 54-bit auto-reload-capable up/down-timers.

The timers' features are summarized as follows:

• a 16-bit clock prescaler, from 1 to 65536

- a 54-bit time-base counter programmable to be incrementing or decrementing
- able to read real-time value of the time-base counter
- halting and resuming the time-base counter
- programmable alarm generation
- level interrupt generation

#### 3.8.2 System Timer

ESP32-C3 family integrates a 52-bit system timer, which has two 52-bit counters and three comparators. The system timer has the following features:

- counters with a fixed clock frequency of 16 MHz
- three types of independent interrupts generated according to alarm value
- two alarm modes: target mode and period mode
- 52-bit target alarm value and 26-bit periodic alarm value
- automatic reload of counter value
- counters can be stalled if the CPU is stalled or in OCD mode

#### 3.8.3 Watchdog Timers

The ESP32-C3 family contains three watchdog timers: one in each of the two timer groups (called Main System Watchdog Timers, or MWDT) and one in the RTC module (called the RTC Watchdog Timer, or RWDT).

During the flash boot process, RWDT and the MWDT in timer group 0 (TIMG0) are enabled automatically in order to detect and recover from booting errors.

Watchdog timers have the following features:

- four stages, each with a programmable timeout value. Each stage can be configured, enabled and disabled separately
- interrupt, CPU reset, or core reset for MWDT upon expiry of each stage; interrupt, CPU reset, core reset, or system reset for RWDT upon expiry of each stage
- 32-bit expiry counter
- write protection, to prevent RWDT and MWDT configuration from being altered inadvertently
- flash boot protection If the boot process from an SPI flash does not complete within a predetermined period of time, the watchdog will reboot the entire main system.

#### Cryptographic Hardware Accelerators 3.9

ESP32-C3 family is equipped with hardware accelerators of general algorithms, such as AES-128/AES-256 (FIPS PUB 197), ECB/CBC/OFB/CFB/CTR (NIST SP 800-38A), SHA1/SHA224/SHA256 (FIPS PUB 180-4), RSA3072, and ECC. The chip also supports independent arithmetic, such as Big Integer Multiplication and Big Integer Modular Multiplication. The maximum operation length for RSA and Big Integer Modular Multiplication is 3072 bits. The maximum factor length for Big Integer Multiplication is 1536 bits.

#### 3.10 **Physical Security Features**

- transparent external flash encryption (AES-XTS algorithm) with software inaccessible key prevents unauthorized readout of user application code or data.
- secure boot feature uses a hardware root of trust to ensure only signed firmware (with RSA-PSS signature) can be booted.
- HMAC module can use a software inaccessible MAC key to generate MAC signatures for identity verification and other purposes.
- Digital Signature module can use a software inaccessible secure key to generate RSA signatures for identity verification.
- · World Controller provides two running environments for software. All hardware and software resources are sorted to two groups, and placed in either secure or general world. The secure world cannot be accessed by hardware in the general world, thus establishing a security boundary.

#### **Peripheral Pin Configurations** 3.11

Table 9: Peripheral Pin Configurations

| Interface | Signal    | Pin           | Function                                     |
|-----------|-----------|---------------|----------------------------------------------|
| ADC       | ADC1_CH0  | XTAL_32K_P    | Two 12-bit SAR ADCs                          |
|           | ADC1_CH1  | XTAL_32K_N    |                                              |
|           | ADC1_CH2  | GPIO2         |                                              |
|           | ADC1_CH3  | GPIO3         |                                              |
|           | ADC1_CH4  | MTMS          |                                              |
|           | ADC2_CH0  | MTDI          |                                              |
| JTAG      | MTDI      | MTDI          | JTAG for software debugging                  |
|           | MTCK      | MTCK          |                                              |
|           | MTMS      | MTMS          |                                              |
|           | MTDO      | MTDO          |                                              |
| UART      | U0RXD_in  | Any GPIO pins | Two UART channels with hardware flow control |
|           | U0CTS_in  |               | and GDMA                                     |
|           | U0DSR_in  |               |                                              |
|           | U0TXD_out |               |                                              |
|           | U0RTS_out |               |                                              |
|           | U0DTR_out |               |                                              |
|           | U1RXD_in  |               |                                              |
|           | U1CTS_in  |               |                                              |
|           | U1DSR_in  |               |                                              |
|           | U1TXD_out |               |                                              |
|           | U1RTS_out |               |                                              |
|           | U1DTR_out |               |                                              |

| Interface       | Signal                  | Pin           | Function                                                   |
|-----------------|-------------------------|---------------|------------------------------------------------------------|
| I2C             | I2CEXT0_SCL_in          | Any GPIO pins | One I2C channel in slave or master mode                    |
|                 | I2CEXT0_SDA_in          |               |                                                            |
|                 | I2CEXT1_SCL_in          |               |                                                            |
|                 | I2CEXT1_SDA_in          |               |                                                            |
|                 | I2CEXT0_SCL_out         |               |                                                            |
|                 | I2CEXT0_SDA_out         |               |                                                            |
|                 | I2CEXT1_SCL_out         |               | _                                                          |
|                 | I2CEXT1_SDA_out         |               |                                                            |
| LED PWM         | ledc_ls_sig_out0~5      | Any GPIO pins | Six independent PWM channels                               |
| I2S             | I2S0O_BCK_in            | Any GPIO pins | Stereo input and output from/to the audiocodec             |
|                 | I2S_MCLK_in             |               |                                                            |
|                 | I2SO_WS_in              |               |                                                            |
|                 | I2SI_SD_in              |               |                                                            |
|                 | I2SI_BCK_in             |               |                                                            |
|                 | I2SI_WS_in              |               |                                                            |
|                 | I2SO_BCK_out            |               |                                                            |
|                 | I2S_MCLK_out            |               |                                                            |
|                 | I2SO_WS_out             |               |                                                            |
|                 | I2SO_SD_out             |               |                                                            |
|                 | I2SI_BCK_out            |               |                                                            |
|                 | I2SI_WS_out             |               |                                                            |
|                 | I2SO_SD1_out            |               |                                                            |
| Remote Control  | RMT_SIG_IN0~1           | Any GPIO pins | Two channels for an IR transceiver of various              |
| Peripheral      | RMT_SIG_OUT0~1          |               | waveforms                                                  |
| SPI0/1          | SPICLK_out_mux          | SPICLK        | Support Standard SPI, Dual SPI, Quad SPI, and              |
|                 | SPICS0_out              | SPICS0        | QPI that allow connection to external flash                |
|                 | SPICS1_out              | Any GPIO pins |                                                            |
|                 | SPID_in/_out            | SPID          |                                                            |
|                 | SPIQ_in/_out            | SPIQ          |                                                            |
|                 | SPIWP_in/_out           | SPIWP         |                                                            |
|                 | SPIHD_in/_out           | SPIHD         |                                                            |
| SPI2            | FSPICLK_in/_out_mux     | Any GPIO pins | Master mode and slave mode of SPI, Dual                    |
|                 | FSPICS0_in/_out         |               | SPI, Quad SPI, and QPI                                     |
|                 | FSPICS1~5_out           |               | <ul> <li>Connection to external flash, RAM, and</li> </ul> |
|                 | FSPID_in/_out           |               | other SPI devices                                          |
|                 | FSPIQ_in/_out           |               | <ul> <li>Four modes of SPI transfer format</li> </ul>      |
|                 | FSPIWP_in/_out          |               | <ul> <li>Configurable SPI frequency</li> </ul>             |
|                 | FSPIHD_in/_out          |               | <ul> <li>64-byte FIFO or GDMA buffer</li> </ul>            |
| USB Serial/JTAG | USB_D+                  | GPIO19        | USB-to-serial converter, and USB-to-JTAG                   |
|                 | USB_D-                  | GPIO18        | converter                                                  |
| TWAI            | twai_rx                 | Any GPIO pins | Compatible with ISO 11898-1 protocol                       |
|                 |                         | 1             |                                                            |
|                 | twai_tx                 |               |                                                            |
|                 | twai_tx twai_bus_off_on |               |                                                            |

## 4. Electrical Characteristics

## 4.1 Absolute Maximum Ratings

Stresses beyond the absolute maximum ratings listed in the table below may cause permanent damage to the device. These are stress ratings only, and do not refer to the functional operation of the device.

Table 10: Absolute Maximum Ratings

| Symbol                    | Parameter                            | Min  | Max | Unit |
|---------------------------|--------------------------------------|------|-----|------|
| VDDA, VDD3P3, VDD3P3_RTC, | Voltage applied to power supply pins | -0.3 | 3.6 | \/   |
| VDD3P3_CPU, VDD_SPI       | per power domain                     | -0.3 | 3.0 | V    |
| $T_{STORE}$               | Storage temperature                  | -40  | 150 | °C   |

## 4.2 Recommended Operating Conditions

**Table 11: Recommended Operating Conditions** 

| Symbol                  | Parameter      |                               | Min | Тур | Max | Unit |
|-------------------------|----------------|-------------------------------|-----|-----|-----|------|
| VDDA, VDD3P3            | Voltage applie | ed to power supply            | 3.0 | 3.3 | 3.6 | V    |
| VDD3P3_RTC              | pins per power | er domain                     | 3,0 | 0.0 | 3.0 | V    |
| VDD_SPI (working as     |                |                               | 3.0 | 3.3 | 3.6 | V    |
| input power supply)1    | -              |                               | 3.0 | 3.3 | 3.0 | V    |
| VDD3P3_CPU <sup>2</sup> | Voltage applie | ed to power supply pin        | 3.0 | 3.3 | 3.6 | V    |
| $I_{VDD}^3$             | Current delive | ered by external power supply | 0.5 | _   |     | Α    |
|                         | Ambient        | ESP32-C3                      |     |     | 105 |      |
| $ T_A $                 |                | ESP32-C3FN4                   | -40 | _   | 85  | °C   |
|                         | temperature    | ESP32-C3FH4                   |     |     | 105 |      |

<sup>&</sup>lt;sup>1</sup> For more information, please refer to Section 2.3 *Power Scheme*.

## 4.3 VDD\_SPI Output Characteristics

Table 12: VDD\_SPI Output Characteristics

| Symbol    | Parameter                   | Тур | Unit |
|-----------|-----------------------------|-----|------|
| $R_{SPI}$ | On-resistance in 3.3 V mode | 7.5 | Ω    |

In real-life applications, when VDD\_SPI works in 3.3 V output mode, VDD3P3\_CPU may be affected by  $R_{SPI}$ . For example, when VDD3P3\_CPU is used to drive a 3.3 V flash, it should comply with the following specifications:

VDD3P3\_CPU > VDD\_flash\_min + I\_flash\_max\*R<sub>SPI</sub>

Among which, VDD\_flash\_min is the minimum operating voltage of the flash, and I\_flash\_max the maximum current.

For more information, please refer to section 2.3 Power Scheme.

<sup>&</sup>lt;sup>2</sup> When VDD\_SPI is used to drive peripherals, VDD3P3\_CPU should comply with the peripherals' specifications. For more information, please refer to Table 12.

<sup>&</sup>lt;sup>3</sup> If you use a single power supply, the recommended output current is 500 mA or more.

## DC Characteristics (3.3 V, 25 °C)

Table 13: DC Characteristics (3.3 V, 25 °C)

| Symbol         | Parameter                                             | Min                     | Тур | Max                    | Unit |
|----------------|-------------------------------------------------------|-------------------------|-----|------------------------|------|
| $C_{IN}$       | Pin capacitance                                       | _                       | 2   | _                      | рF   |
| $V_{IH}$       | High-level input voltage                              | 0.75 × VDD <sup>1</sup> |     | VDD <sup>1</sup> + 0.3 | V    |
| $V_{IL}$       | Low-level input voltage                               | -0.3                    | _   | $0.25 \times VDD^1$    | V    |
| $ I_{IH} $     | High-level input current                              | _                       |     | 50                     | nA   |
| <sub>IL</sub>  | Low-level input current                               | _                       |     | 50                     | nA   |
| $V_{OH}^2$     | High-level output voltage                             | $0.8 \times VDD^1$      |     | 4-                     | V    |
| $V_{OL}^2$     | Low-level output voltage                              | _                       | _   | $0.1 \times VDD^1$     | V    |
| 1.             | High-level source current (VDD1= 3.3 V,               |                         | 40  |                        | mA   |
| $     _{OH}$   | $V_{OH} >= 2.64 \text{ V, PAD_DRIVER} = 3)$           | _                       | 40  |                        | IIIA |
| 1.             | Low-level sink current (VDD $^1$ = 3.3 V, V $_{OL}$ = |                         | 28  |                        | mA   |
| $  I_{OL}  $   | 0.495 V, PAD_DRIVER = 3)                              | _ 1                     | 20  | _                      | IIIA |
| $R_{PU}$       | Pull-up resistor                                      |                         | 45  | _                      | kΩ   |
| $R_{PD}$       | Pull-down resistor                                    | _                       | 45  | _                      | kΩ   |
| $V_{IH\_nRST}$ | Chip reset release voltage                            | $0.75 \times VDD^1$     | 1   | VDD <sup>1</sup> + 0.3 | V    |
| $V_{IL\_nRST}$ | Chip reset voltage                                    | -0.3                    | 77  | $0.25 \times VDD^1$    | V    |

<sup>&</sup>lt;sup>1</sup> VDD is the I/O voltage for a particular power domain of pins.

## **ADC Characteristics**

**Table 14: ADC Characteristics** 

| Symbol                                       | Parameter                          | Min        | Max  | Unit |
|----------------------------------------------|------------------------------------|------------|------|------|
| DNL (Differential nonlinearity) <sup>1</sup> | ADC connected to an external       | <b>-</b> 7 | 7    | LSB  |
| DNE (billerential norillinearity)            | 100 nF capacitor; DC signal input; | -1         | 1    | LOD  |
| INL (Integral nonlinearity)                  | ambient temperature at 25 °C;      | -12        | 12   | LSB  |
| INC (Integral normineality)                  | Wi-Fi off                          | -12        | 12   | LOD  |
| Sampling rate                                | _                                  | _          | 2    | Msps |
|                                              | ATTEN0                             | 0          | 750  | mV   |
| Effective Range                              | ATTEN1                             | 0          | 1050 | mV   |
| Lilective I tailige                          | ATTEN2                             | 0          | 1300 | mV   |
|                                              | ATTEN3                             | 0          | 2500 | mV   |

<sup>&</sup>lt;sup>1</sup> To get better DNL results, you can sample multiple times and apply a filter, or calculate the average value.

## **Current Consumption**

The current consumption measurements are taken with a 3.3 V supply at 25 °C of ambient temperature at the RF port. All transmitters' measurements are based on a 100% duty cycle.

 $<sup>^{2}</sup>$   $V_{OH}$  and  $V_{OL}$  are measured using high-impedance load.

Table 15: Current Consumption Depending on RF Modes

| Work mode           | Description |                                 | Peak |  |
|---------------------|-------------|---------------------------------|------|--|
|                     |             |                                 | (mA) |  |
|                     | T.          | 802.11b, 1 Mbps, @21 dBm        | 335  |  |
|                     |             | 802.11g, 54 Mbps, @19 dBm       | 285  |  |
| Active (DE working) | TX          | 802.11n, HT20, MCS 7, @18.5 dBm | 276  |  |
| Active (RF working) |             | 802.11n, HT40, MCS 7, @18.5 dBm | 278  |  |
|                     | RX          | 802.11b/g/n, HT20               | 84   |  |
|                     |             | 802.11n, HT40                   | 87   |  |

Table 16: Current Consumption Depending on Work Modes

| Work mode                   | Description                                          |         | Тур     | Unit |
|-----------------------------|------------------------------------------------------|---------|---------|------|
| Modem-sleep <sup>1, 2</sup> | The CPU is                                           | 160 MHz | 20      | mA   |
| Modern-Sieep                | powered on <sup>3</sup>                              | 80 MHz  | 15      | mA   |
| Light-sleep                 | _                                                    |         | 130     | μΑ   |
| Deep-sleep                  | RTC timer + R                                        | 5       | $\mu$ A |      |
| Power off                   | CHIP_PU is set to low level, the chip is powered off |         | 1       | μΑ   |

<sup>&</sup>lt;sup>1</sup> The current consumption figures in Modem-sleep mode are for cases where the CPU is powered on and the cache idle.

#### 4.7 Reliability

Table 17: Reliability Qualifications

| Test Item                | Test Conditions                                       | Test Standard      |
|--------------------------|-------------------------------------------------------|--------------------|
| HTOL (High Temperature   | 125 °C, 1000 hours                                    | JESD22-A108        |
| Operating Life)          | 123 O, 1000 Hours                                     | JL3D22-A100        |
| ESD (Electro-Static      | HBM (Human Body Mode) <sup>1</sup> ± 2000 V           | JESD22-A114        |
| Discharge Sensitivity)   | CDM (Charge Device Mode) <sup>2</sup> ± 500 V         | JESD22-C101F       |
| Latch up                 | Current trigger ± 200 mA                              | JESD78             |
| Laterrup                 | Voltage trigger 1.5 × VDD $_{max}$                    | JESDIO             |
|                          | Bake 24 hours @125 °C                                 | J-STD-020, JESD47, |
| Preconditioning          | Moisture soak (level 3: 192 hours @30 °C, 60% RH)     | JESD22-A113        |
|                          | IR reflow solder: 260 + 0 °C, 20 seconds, three times | 0L0D22-A110        |
| TCT (Temperature Cycling | _65 °C / 150 °C, 500 cycles                           | JESD22-A104        |
| Test)                    | -03 07 130 0, 300 cycles                              | ULUD22-A104        |
| Autoclave Test           | 121 °C, 100% RH, 96 hours                             | JESD22-A102        |

<sup>&</sup>lt;sup>2</sup> When Wi-Fi is enabled, the chip switches between Active and Modern-sleep modes. Therefore, current consumption changes accordingly.

<sup>&</sup>lt;sup>3</sup> In Modem-sleep mode, the CPU frequency changes automatically. The frequency depends on the CPU load and the peripherals used.

Table 17 - cont'd from previous page

| Test Item                | Test Conditions          | Test Standard |
|--------------------------|--------------------------|---------------|
| uHAST (Highly            |                          |               |
| Accelerated Stress Test, | 130 °C, 85% RH, 96 hours | JESD22-A118   |
| unbiased)                |                          |               |
| HTSL (High Temperature   | 150 °C 1000 bours        | JESD22-A103   |
| Storage Life)            | 150 °C, 1000 hours       | JESD22-A103   |

<sup>&</sup>lt;sup>1</sup> JEDEC document JEP155 states that 500 V HBM allows safe manufacturing with a standard ESD control process.

#### Wi-Fi Radio 4.8

Table 18: Wi-Fi Frequency

| Parameter                             | Min   | Typ   | Max   |
|---------------------------------------|-------|-------|-------|
|                                       | (MHz) | (MHz) | (MHz) |
| Center frequency of operating channel | 2412  |       | 2484  |

## 4.8.1 Wi-Fi RF Transmitter (TX) Specifications

Table 19: TX Power with Spectral Mask and EVM Meeting 802.11 Standards

| Data                | Min   | Тур   | Max   |
|---------------------|-------|-------|-------|
| Rate                | (dBm) | (dBm) | (dBm) |
| 802.11b, 1 Mbps     | _     | 21.0  |       |
| 802.11b, 11 Mbps    | _     | 21.0  | _     |
| 802.11g, 6 Mbps     | _     | 21.0  |       |
| 802.11g, 54 Mbps    |       | 19.0  | _     |
| 802.11n, HT20, MCS0 |       | 20.0  | _     |
| 802.11n, HT20, MCS7 |       | 18.5  | _     |
| 802.11n, HT40, MCS0 | _     | 20.0  | _     |
| 802.11n, HT40, MCS7 | _     | 18.5  |       |

Table 20: TX EVM Test

| Rate                           | Min  | Тур   | SL <sup>1</sup> |
|--------------------------------|------|-------|-----------------|
| nate                           | (dB) | (dB)  | (dB)            |
| 802.11b, 1 Mbps, @21 dBm       | _    | -24.5 | -10             |
| 802.11b, 11 Mbps, @21 dBm      |      | -25.0 | -10             |
| 802.11g, 6 Mbps, @21 dBm       | _    | -23.0 | -5              |
| 802.11g, 54 Mbps, @19 dBm      |      | -27.5 | -25             |
| 802.11n, HT20, MSC0, @20 dBm   | _    | -22.5 | <b>-</b> 5      |
| 802.11n, HT20, MSC7, @18.5 dBm | _    | -29.0 | -27             |
| 802.11n, HT40, MSC0, @20 dBm   | _    | -22.5 | -5              |
| 802.11n, HT40, MSC7, @18.5 dBm |      | -28.0 | -27             |

<sup>&</sup>lt;sup>1</sup> SL stands for standard limit value.

<sup>&</sup>lt;sup>2</sup> JEDEC document JEP157 states that 250 V CDM allows safe manufacturing with a standard ESD control process.

## 4.8.2 Wi-Fi RF Receiver (RX) Specifications

Table 21: RX Sensitivity

| Data                | Min   | Тур   | Max   |
|---------------------|-------|-------|-------|
| Rate                | (dBm) | (dBm) | (dBm) |
| 802.11b, 1 Mbps     | _     | -98.4 | _     |
| 802.11b, 2 Mbps     | _     | -96.0 | _     |
| 802.11b, 5.5 Mbps   | _     | -93.0 | _     |
| 802.11b, 11 Mbps    | _     | -88.6 | _     |
| 802.11g, 6 Mbps     | _     | -93.8 | _     |
| 802.11g, 9 Mbps     | _     | -92.2 |       |
| 802.11g, 12 Mbps    | _     | -91.0 | _     |
| 802.11g, 18 Mbps    | _     | -88.4 | _     |
| 802.11g, 24 Mbps    | _     | -85.8 |       |
| 802.11g, 36 Mbps    | _     | -82.0 | L     |
| 802.11g, 48 Mbps    | _     | -78.0 | >-    |
| 802.11g, 54 Mbps    | _     | -76.6 | _     |
| 802.11n, HT20, MCS0 | _     | -93.6 | _     |
| 802.11n, HT20, MCS1 |       | -90.8 | _     |
| 802.11n, HT20, MCS2 | _     | -88.4 | _     |
| 802.11n, HT20, MCS3 |       | -85.0 |       |
| 802.11n, HT20, MCS4 | _     | -81.8 | _     |
| 802.11n, HT20, MCS5 |       | -77.8 | _     |
| 802.11n, HT20, MCS6 | _     | -76.0 | _     |
| 802.11n, HT20, MCS7 |       | -74.8 | _     |
| 802.11n, HT40, MCS0 |       | -90.0 | _     |
| 802.11n, HT40, MCS1 |       | -88.0 | _     |
| 802.11n, HT40, MCS2 |       | -85.2 | _     |
| 802.11n, HT40, MCS3 |       | -82.0 |       |
| 802.11n, HT40, MCS4 | _     | -78.8 | _     |
| 802.11n, HT40, MCS5 | _     | -74.6 | _     |
| 802.11n, HT40, MCS6 | _     | -73.0 | _     |
| 802.11n, HT40, MCS7 | _     | -71.4 | _     |

Table 22: Maximum RX Level

| Rate                | Min<br>(dBm) | Typ<br>(dBm) | Max<br>(dBm) |
|---------------------|--------------|--------------|--------------|
| 802.11b, 1 Mbps     | _            | 5            | _            |
| 802.11b, 11 Mbps    | _            | 5            | _            |
| 802.11g, 6 Mbps     | _            | 5            | _            |
| 802.11g, 54 Mbps    | _            | 0            | _            |
| 802.11n, HT20, MCS0 | _            | 5            | _            |
| 802.11n, HT20, MCS7 | _            | 0            | _            |

Table 22 - cont'd from previous page

| Rate                | Min<br>(dBm) | Typ<br>(dBm) | Max<br>(dBm) |
|---------------------|--------------|--------------|--------------|
| 802.11n, HT40, MCS0 | _            | 5            | _            |
| 802.11n, HT40, MCS7 | _            | 0            | _            |

Table 23: RX Adjacent Channel Rejection

| Rate                | Min<br>(dB) | Typ<br>(dB) | Max<br>(dB) |
|---------------------|-------------|-------------|-------------|
| 802.11b, 1 Mbps     | _           | 35          |             |
| 802.11b, 11 Mbps    |             | 35          |             |
| 802.11g, 6 Mbps     | _           | 31          | <u> </u>    |
| 802.11g, 54 Mbps    | _           | 20          |             |
| 802.11n, HT20, MSC0 | _           | 31          |             |
| 802.11n, HT20, MSC7 | _           | 16          |             |
| 802.11n, HT40, MSC0 | -           | 25          | _           |
| 802.11n, HT40, MSC7 | _           | 11          | _           |

## 4.9 Bluetooth LE Radio

Table 24: Bluetooth LE Frequency

| Parameter                             | Min   | Typ   | Max   |
|---------------------------------------|-------|-------|-------|
|                                       | (MHz) | (MHz) | (MHz) |
| Center frequency of operating channel | 2402  | _     | 2480  |

#### Bluetooth LE RF Transmitter (TX) Specifications 4.9.1

Table 25: Transmitter Characteristics - Bluetooth LE 1 Mbps

| Parameter                          | Description                                         | Min    | Тур      | Max   | Unit  |
|------------------------------------|-----------------------------------------------------|--------|----------|-------|-------|
| DE transmit namer                  | RF power control range                              | -27.00 | 0        | 18.00 | dBm   |
| RF transmit power                  | Gain control step                                   | _      | 3.00     | _     | dB    |
| Carrier frequency offset and drift | $  \text{Max}  _{n=0,\ 1,\ 2,\k}$                   | _      | 17.00    | _     | kHz   |
|                                    | $Max \left  f_0 - f_n \right $                      | _      | 1.75     | _     | kHz   |
|                                    | $ Max f_{n-}f_{n-5} $                               | _      | 1.46     | _     | kHz   |
|                                    | $ f_1 - f_0 $                                       | _      | 0.80     | _     | kHz   |
|                                    | $\Delta f1_{avg}$                                   | _      | 250.00   | _     | kHz   |
| Modulation characteristics         | Min $\Delta$ $f2_{\rm max}$ (for at least           |        | — 190.00 | _     | kHz   |
| Woodiation characteristics         | 99.9% of all $\Delta$ $f2_{\rm max}$ )              |        |          |       | KI IZ |
|                                    | $\Delta~f2_{\mathrm{avg}}/\Delta~f1_{\mathrm{avg}}$ | _      | 0.83     |       | _     |
| In-band spurious emissions         | ± 2 MHz offset                                      | _      | -37.62   | _     | dBm   |
|                                    | ± 3 MHz offset                                      | _      | -41.95   | _     | dBm   |
|                                    | ± > 3 MHz offset                                    | _      | -44.48   | _     | dBm   |

Table 26: Transmitter Characteristics - Bluetooth LE 2 Mbps

| Parameter                          | Description                               | Min    | Тур    | Max   | Unit |
|------------------------------------|-------------------------------------------|--------|--------|-------|------|
| DE transmit navyer                 | RF power control range                    | -27.00 | 0      | 18.00 | dBm  |
| RF transmit power                  | Gain control step                         |        | 3.00   | _     | dB   |
| Carrier frequency offset and drift | $  \text{Max}  _{n=0,\;1,\;2,\;k}$        |        | 20.80  | _     | kHz  |
|                                    | $Max \left  f_0 - f_n \right $            |        | 1.30   | _     | kHz  |
|                                    | $Max \left  f_{n-} f_{n-5} \right $       |        | 1.33   | _     | kHz  |
|                                    | $ f_1-f_0 $                               | _      | 0.70   | _     | kHz  |
|                                    | $\Delta f1_{avg}$                         | _      | 498.00 | _     | kHz  |
| Modulation characteristics         | Min $\Delta$ $f2_{\rm max}$ (for at least |        | 430.00 |       | kHz  |
|                                    | 99.9% of all $\Delta$ $f2_{\text{max}}$ ) |        |        |       |      |
|                                    | $\Delta~f2_{ m avg}/\Delta~f1_{ m avg}$   | _      | 0.93   | _     |      |
| In-band spurious emissions         | ± 4 MHz offset                            |        | -43.55 |       | dBm  |
|                                    | ± 5 MHz offset                            | _      | -45.26 |       | dBm  |
|                                    | ± > 5 MHz offset                          | -      | -45.26 | _     | dBm  |

Table 27: Transmitter Characteristics - Bluetooth LE 125 Kbps

| Parameter                          | Description                               | Min    | Тур    | Max   | Unit  |
|------------------------------------|-------------------------------------------|--------|--------|-------|-------|
| RF transmit power                  | RF power control range                    | -27.00 | 0      | 18.00 | dBm   |
| τη παιδιτήτροννοι                  | Gain control step                         | _      | 3.00   |       | dB    |
| Carrier frequency offset and drift | $  \text{Max}   f_n  _{n=0,\;1,\;2,\;k}$  | _      | 17.50  | _     | kHz   |
|                                    | $Max  f_0 - f_n $                         | _      | 0.45   | _     | kHz   |
|                                    | $ f_n - f_{n-3} $                         | _      | 0.70   | _     | kHz   |
|                                    | $ f_0-f_3 $                               | _      | 0.30   |       | kHz   |
|                                    | $\Delta f1_{avg}$                         | _      | 250.00 |       | kHz   |
| Modulation characteristics         | Min $\Delta$ $f1_{\max}$ (for at least    |        | 235.00 |       | kHz   |
|                                    | 99.9% of all $\Delta$ $f2_{\text{max}}$ ) | _      | 200.00 | _     | NI IZ |
|                                    | ± 2 MHz offset                            | _      | -37.90 |       | dBm   |
| In-band spurious emissions         | ± 3 MHz offset                            | _      | -41.00 | _     | dBm   |
|                                    | ± > 3 MHz offset                          | _      | -42.50 | _     | dBm   |

Table 28: Transmitter Characteristics - Bluetooth LE 500 Kbps

| Parameter                          | Description                               | Min    | Тур    | Max   | Unit  |
|------------------------------------|-------------------------------------------|--------|--------|-------|-------|
| DE transmit newer                  | RF power control range                    | -27.00 | 0      | 18.00 | dBm   |
| RF transmit power                  | Gain control step                         | _      | 3.00   | _     | dB    |
|                                    | $  Max  _{n=0,\ 1,\ 2,\k}$                | _      | 17.00  |       | kHz   |
| Coming from the standard and drift | $Max \left  f_0 - f_n \right $            | _      | 0.88   | _     | kHz   |
| Carrier frequency offset and drift | $ f_n - f_{n-3} $                         | _      | 1.00   | _     | kHz   |
|                                    | $ f_0-f_3 $                               | _      | 0.20   | _     | kHz   |
|                                    | $\Delta~f2_{	ext{avg}}$                   | _      | 208.00 |       | kHz   |
| Modulation characteristics         | Min $\Delta$ $f2_{\rm max}$ (for at least |        | 190.00 |       | kHz   |
|                                    | 99.9% of all $\Delta$ $f2_{ m max}$ )     |        | 190.00 | _     | NI IZ |

Table 28 - cont'd from previous page

| Parameter                  | Description      | Min | Тур    | Max | Unit |
|----------------------------|------------------|-----|--------|-----|------|
|                            | ± 2 MHz offset   | _   | -37.90 | _   | dBm  |
| In-band spurious emissions | ± 3 MHz offset   | _   | -41.30 |     | dBm  |
|                            | ± > 3 MHz offset | _   | -42.80 |     | dBm  |

## 4.9.2 Bluetooth LE RF Receiver (RX) Specifications

Table 29: Receiver Characteristics - Bluetooth LE 1 Mbps

| Parameter                           | Description                     | Min | Тур | Max | Unit |
|-------------------------------------|---------------------------------|-----|-----|-----|------|
| Sensitivity @30.8% PER              | _                               | _   | -97 | _   | dBm  |
| Maximum received signal @30.8% PER  | _                               | _   | 5   |     | dBm  |
| Co-channel C/I                      | _                               | _   | 8   |     | dB   |
|                                     | F = F0 + 1 MHz                  | _   | -3  |     | dB   |
|                                     | F = F0 – 1 MHz                  |     | -4  |     | dB   |
|                                     | F = F0 + 2 MHz                  |     | -29 | _   | dB   |
| Adjacent channel selectivity C/I    | F = F0 - 2 MHz                  |     | -31 |     | dB   |
| Adjacent channel selectivity C/1    | F = F0 + 3 MHz                  | 1   | -33 | _   | dB   |
|                                     | F = F0 - 3 MHz                  | _   | -27 |     | dB   |
|                                     | $F \ge F0 + 4 MHz$              |     | -29 | _   | dB   |
|                                     | $F \le F0 - 4 MHz$              |     | -38 |     | dB   |
| Image frequency                     | _                               | _   | -29 |     | dB   |
| Adjacent channel to image frequency | $F = F_{image} + 1 \text{ MHz}$ | _   | -41 | _   | dB   |
| Adjacent channel to image frequency | $F = F_{image} - 1 \text{ MHz}$ | _   | -33 | _   | dB   |
| Out-of-band blocking performance    | 30 MHz ~ 2000 MHz               | _   | -5  |     | dBm  |
|                                     | 2003 MHz ~ 2399 MHz             | _   | -18 | _   | dBm  |
|                                     | 2484 MHz ~ 2997 MHz             | _   | -15 | _   | dBm  |
|                                     | 3000 MHz ~ 12.75 GHz            |     | -5  |     | dBm  |
| Intermodulation                     | <b>/</b>                        | _   | -30 | _   | dBm  |

Table 30: Receiver Characteristics - Bluetooth LE 2 Mbps

| Parameter                          | Description                | Min | Тур | Max | Unit |
|------------------------------------|----------------------------|-----|-----|-----|------|
| Sensitivity @30.8% PER             | _                          | _   | -93 | _   | dBm  |
| Maximum received signal @30.8% PER | _                          | _   | 5   | _   | dBm  |
| Co-channel C/I                     | _                          | _   | 10  | _   | dB   |
|                                    | F = F0 + 2 MHz             | _   | -7  | _   | dB   |
|                                    | F = F0 – 2 MHz             | _   | -7  | _   | dB   |
|                                    | F = F0 + 4 MHz             | _   | -28 | _   | dB   |
| Adjacent channel selectivity C/I   | F = F0 – 4 MHz             | _   | -26 | _   | dB   |
|                                    | F = F0 + 6 MHz             | _   | -26 | _   | dB   |
|                                    | F = F0 – 6 MHz             | _   | -27 | _   | dB   |
|                                    | $F \ge F0 + 8 \text{ MHz}$ |     | -29 |     | dB   |
|                                    | $F \le F0 - 8 MHz$         | _   | -28 | _   | dB   |

Table 30 - cont'd from previous page

| Parameter                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                      | Description                     | Min | Тур | Max | Unit |
|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|---------------------------------|-----|-----|-----|------|
| Image frequency                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                | _                               | _   | -28 |     | dB   |
| A discount of a second decision of the second | $F = F_{image} + 2 MHz$         | _   | -26 | _   | dB   |
| Adjacent channel to image frequency                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                            | $F = F_{image} - 2 \text{ MHz}$ | _   | -7  | _   | dB   |
| Out-of-band blocking performance                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                               | 30 MHz ~ 2000 MHz               | _   | -5  | _   | dBm  |
|                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                | 2003 MHz ~ 2399 MHz             | _   | -19 | _   | dBm  |
|                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                | 2484 MHz ~ 2997 MHz             | _   | -16 |     | dBm  |
|                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                | 3000 MHz ~ 12.75 GHz            | _   | -5  | _   | dBm  |
| Intermodulation                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                | _                               | _   | -29 |     | dBm  |

Table 31: Receiver Characteristics - Bluetooth LE 125 Kbps

| Parameter                           | Description                     | Min | Тур  | Max      | Unit |
|-------------------------------------|---------------------------------|-----|------|----------|------|
| Sensitivity @30.8% PER              | _                               |     | -105 | _        | dBm  |
| Maximum received signal @30.8% PER  | _                               |     | 5    | <u> </u> | dBm  |
| Co-channel C/I                      | _                               | -   | 3    | _        | dB   |
|                                     | F = F0 + 1 MHz                  | X   | -6   | _        | dB   |
|                                     | F = F0 – 1 MHz                  |     | -6   | _        | dB   |
| Adia a cut alcausada alcaticit (O/I | F = F0 + 2 MHz                  |     | -33  | _        | dB   |
|                                     | F = F0 – 2 MHz                  | _   | -43  | _        | dB   |
| Adjacent channel selectivity C/I    | F = F0 + 3 MHz                  | _   | -37  |          | dB   |
|                                     | F = F0 - 3  MHz                 | _   | -47  | _        | dB   |
|                                     | F ≥ F0 + 4 MHz                  | _   | -40  | _        | dB   |
|                                     | $F \le F0 - 4 MHz$              | _   | -50  | _        | dB   |
| Image frequency                     | -                               | _   | -40  | _        | dB   |
| Adjacent channel to image frequency | $F = F_{image} + 1 \text{ MHz}$ | _   | -50  | _        | dB   |
|                                     | $F = F_{image} - 1 \text{ MHz}$ | _   | -37  |          | dB   |

Table 32: Receiver Characteristics - Bluetooth LE 500 Kbps

| Parameter                          | Description        | Min | Тур  | Max | Unit |
|------------------------------------|--------------------|-----|------|-----|------|
| Sensitivity @30.8% PER             | _                  | _   | -100 |     | dBm  |
| Maximum received signal @30.8% PER | _                  | _   | 5    | _   | dBm  |
| Co-channel C/I                     | _                  | _   | 3    |     | dB   |
|                                    | F = F0 + 1 MHz     | _   | -2   | _   | dB   |
|                                    | F = F0 - 1 MHz     | _   | -3   |     | dB   |
|                                    | F = F0 + 2 MHz     |     | -32  | _   | dB   |
| Adjacent channel selectivity C/I   | F = F0 - 2 MHz     | _   | -33  | _   | dB   |
| Adjacent channel selectivity 0/1   | F = F0 + 3 MHz     |     | -23  | _   | dB   |
|                                    | F = F0 - 3 MHz     | _   | -40  |     | dB   |
|                                    | $F \ge F0 + 4 MHz$ | _   | -34  |     | dB   |
|                                    | $F \le F0 - 4 MHz$ |     | -44  |     | dB   |
| Image frequency                    | _                  |     | -34  |     | dB   |

Table 32 - cont'd from previous page

| Parameter                           | Description                     | Min | Тур | Max | Unit |
|-------------------------------------|---------------------------------|-----|-----|-----|------|
| Adjacent channel to image frequency | $F = F_{image} + 1 \text{ MHz}$ |     | -46 |     | dB   |
|                                     | $F = F_{image} - 1 \text{ MHz}$ |     | -23 | _   | dB   |



## **Package Information**

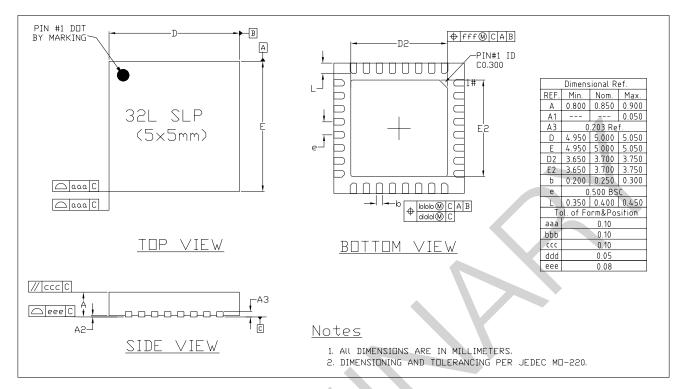


Figure 8: QFN32 (5×5 mm) Package

#### Note:

For information about tape, reel, and product marking, please refer to *Espressif Chip-Packing Information*.

## **Revision History**

## Solutions, Documentation and Legal Information

#### **Must-Read Documents**

- ESP32-C3 Technical Reference Manual
- ESP-IDF Programming Guide
- Espressif Product Ordering Information
- Certificates
- Notification Subscription

#### Sales and Technical Support

- Sales Questions
- Technical Inquiries
- Get Samples

#### **Developer Zone**

• ESP32 Forum

- GitHub
- Courses
- Videos

#### **Products**

- SoCs
- Modules
- DevKits

#### **Must-Have Resources**

- SDKs and Demos
- APPs
- Tools
- AT





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